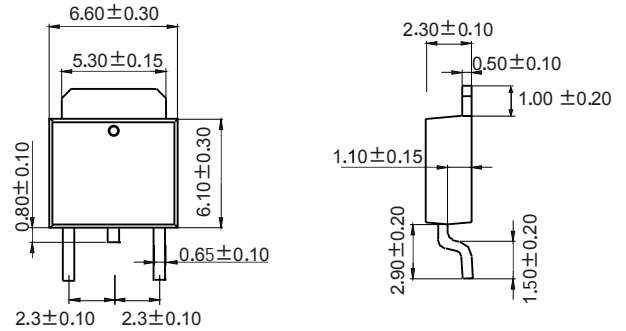




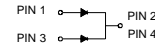
Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Construction utilizes void-free molded plastic technique
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed
250°C/10 seconds at terminals

TO-252



Dimensions in millimeters



Mechanical Data

Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	MBR 1020DT	MBR 1040DT	MBR 1045DT	MBR 1060DT	MBR 10100DT	MBR 10150DT	MBR 10200DT	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	20	40	45	60	100	150	200	V
Maximum RMS voltage	V_{RMS}	14	28	31.5	42	70	105	140	V
Maximum DC blocking voltage	V_{DC}	20	40	45	60	100	150	200	V
Maximum average forward rectified current at $T_c=100^\circ\text{C}$ per device per diode	$I_{(AV)}$					10.0 5.0			A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}					125.0			A
Maximum instantaneous forward voltage per diode at 5.0A	V_F	0.70		0.80	0.85	0.95		V	
Maximum DC reverse current at rated DC blocking voltage $T_A=25^\circ\text{C}$ $T_A=100^\circ\text{C}$	I_R	0.5 50			0.05 10				mA
Typical thermal resistance	R_{qJC}					3.0			°C/W
Operating junction temperature range	T_J	-55 to +125			-55 to +150				°C
Storage temperature range	T_{STG}	-55 to +125			-55 to +150				°C

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

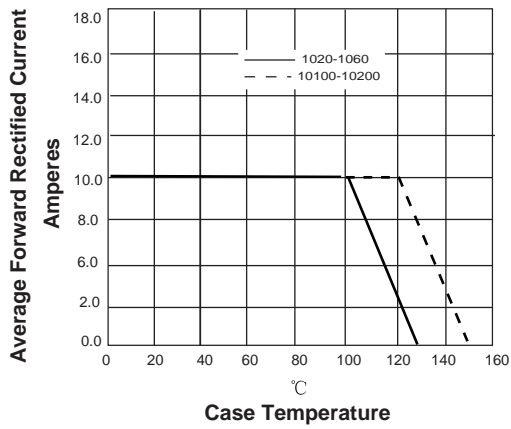


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER LEG

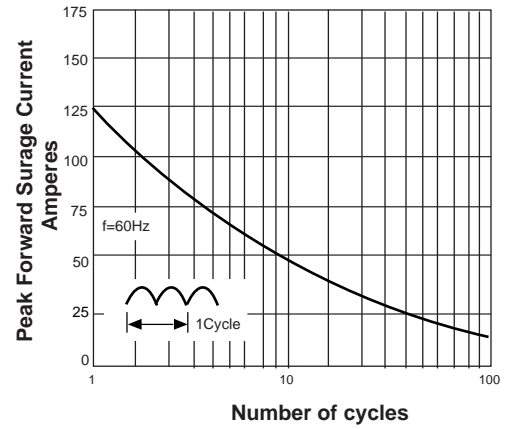


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

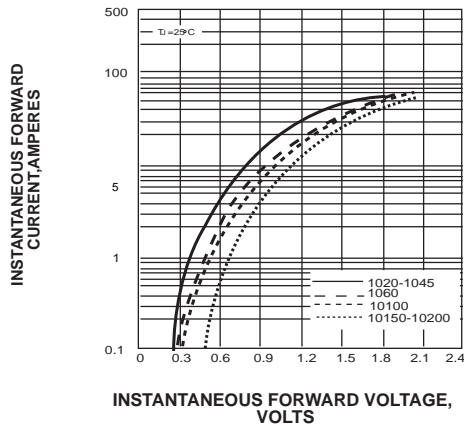


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS

